

Chipsmall Limited consists of a professional team with an average of over 10 year of expertise in the distribution of electronic components. Based in Hongkong, we have already established firm and mutual-benefit business relationships with customers from, Europe, America and south Asia, supplying obsolete and hard-to-find components to meet their specific needs.

With the principle of "Quality Parts, Customers Priority, Honest Operation, and Considerate Service", our business mainly focus on the distribution of electronic components. Line cards we deal with include Microchip, ALPS, ROHM, Xilinx, Pulse, ON, Everlight and Freescale. Main products comprise IC, Modules, Potentiometer, IC Socket, Relay, Connector. Our parts cover such applications as commercial, industrial, and automotives areas.

We are looking forward to setting up business relationship with you and hope to provide you with the best service and solution. Let us make a better world for our industry!



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PS11 D 5 W D Surface Mount Phototransistor/Dome Lens Type

Features

Package

Dome Lenz Type

1105WA: Water clear epoxy

1195WB: Black Visible Radiation Cut Filter epoxy

Product features	 Outer Dimension 3.2 x 1.6 x 1.85mm (LxWxH) High Sensitivity Narrow Distribution Photo Current: 8.0mA TYP. (V_{CE}=5V,Ee=5mW/cm²) Visible Radiation Cut Filter under 700nm(1195WB) Lead-free soldering compatible RoHS compliant

Peak Sensitivity Wavelength	880nm(1105WA), 900nm(1195WB)
Half Intensity Angle	45 deg.
Die materials	Si
Rank grouping parameter	Sorted by photo current per rank taping
Assembly method	Auto pick & place machine (Auto Mounter)
Soldering methods	Reflow soldering XPlease refer to Soldering Conditions about soldering.
Taping and reel	2,000pcs per reel in a 8mm width tape. (Standard) Reel diameter: ϕ 180mm
ESD	2kV (HBM)

Recommended Applications

Car Audio, Electric Household Appliances, OA/FA, PC/Peripheral Equipment, Other General Applications





Absolute Maximum Ratings

(Ta=25℃)

lte m	Symbol	Abs olute Maximum Ratings	Unit	
Collector Dissipation	Pc	75	mW	
Collector-Emitter Voltage	V _{CEO}	30	V	
Emitter-Collector Voltage	V _{ECO}	5	V	
Collector Current	lc	20	mA	
Operating Temperature	Topr	-30~+85	C	
Storage Temperature	Tstg	-40~+90	C	

Electro-Optical Characteristics

(Ta=25°C)

lte m		Symbol	Characteristics		Unit
item	Conditions	3 yilibol		1105WA 1195WB	
	V - FV	lc	Min.	1.6	mA
Photo Current	V _{CE} =5V, Ee=5mW/cm ² **1		TYP.	8	mA
			Max.	19	mA
Response Time	$V_{CE}=10V$, $Ic=2mA$, $R_L=100 \Omega$	tr/tf	TYP.	8/9	μs
Dark Current	V _{CEO} =10V	I _{CEO}	Max.	0.1	μА
Peak Sensitivity Wavelength	V _{CE} =5V	λр	TYP.	880 900	nm
S patial Half Width	V _{CE} =5V	2θ1/2	TYP.	45	deg.

※1 Color temperature is 2,856K. Employs a standard tungsten lamp.





Photo Current Rank

(Ta=25℃)

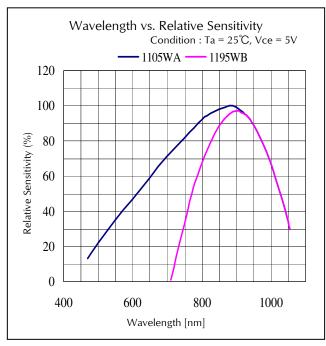
Rank	lc(ı	Condition		
Kalik	MIN.	MAX.	Condition	
Α	1.6	3.2		
В	2.8	5.6		
С	4.8	9.6	$V_{CE} = 5V$ $E e = 5 \text{mW/cm}^2$	
D	8.4	16.8		
E	14.4	19.0		

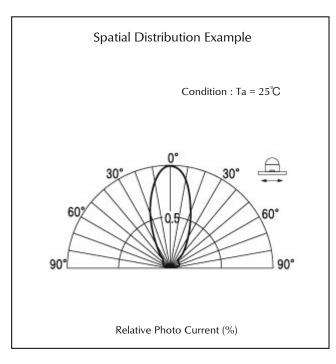
XPlease contact our sales staff concerning rank designation.

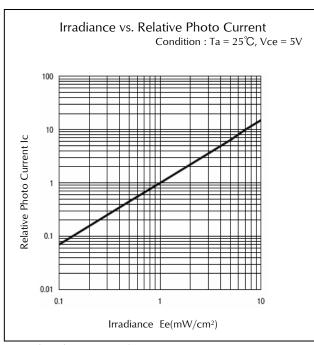


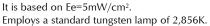


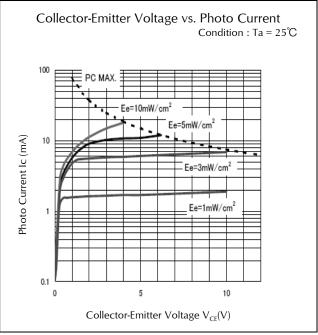
Technical Data









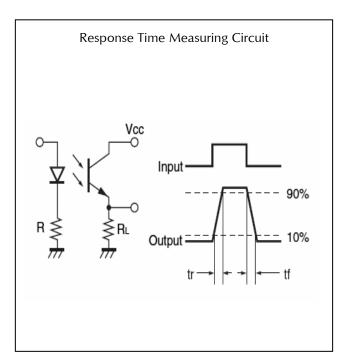


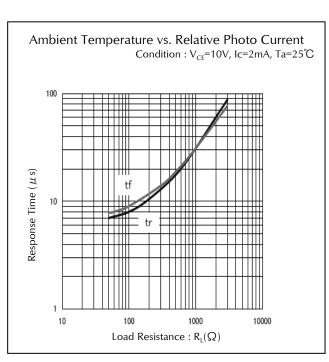
Employs a standard tungsten lamp of 2,856K.

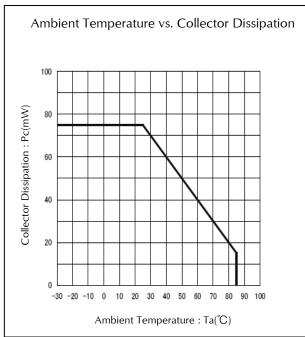


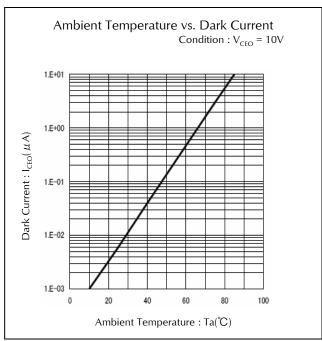


Technical Data





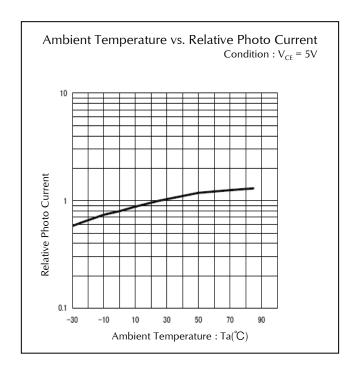








Technical Data



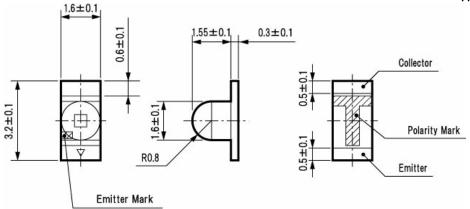




Package Dimensions

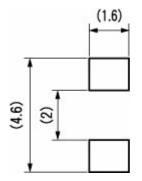
(Unit: mm)

Weight: (7.80)mg



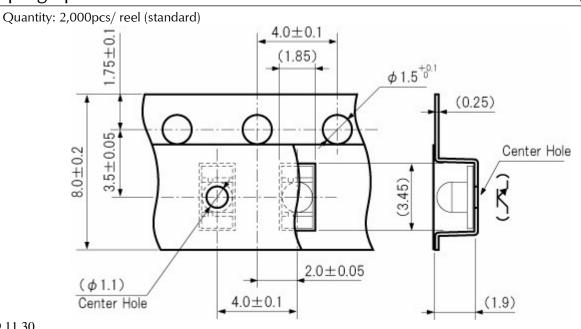
Recommended Soldering Pattern

(Unit: mm)



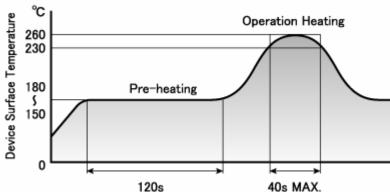
Taping Specification

(Unit: mm)





Reflow Soldering Conditions



- 1) The above profile temperature gives the maximum temperature of the device resin surface. Please set the temperature so as to avoid exceeding this range.
- 2) Total times of reflow soldering process shall be no more than 2 times. When the second reflow soldering process is performed, intervals between the first and second reflow should be short as possible (while allowing some time for the component to return to normal temperature after the first reflow) in order to prevent the device from absorbing moisture.
- 3) Temperature fluctuation to the device during the pre-heating process shall be minimized.

Manual Soldering Conditions

Iron tip temp.	350 ℃	(MAX.) (30 W Max.)
Soldering time and frequency	3 s 1 time	(MAX.) (MAX.)





Reliability Testing Result

Reliability Testing Result	Applicable Standard	Testing Conditions	Duration	Failure
Room Temp. Operating Life	EIAJ ED- 4701/100(101)	Ta = 25°C, Pc = Maxium Rated Power Dissipation	1,000 h	0/16
Resistance to Soldering Heat	EIAJ ED- 4701/300(301)	(Pretreatment) Individual standard (Reflow Soldering) Pre-heating 150°C~180°C 120s Operating Heating 230°C Min. Peak temperature 260°C	Twice	0/16
Temperature Cycling	EIAJ ED- 4701/100(105)	Minimum Rated Storage Temperature(30min) Normal Temperature(15min) Maximum Rated Storage Temperature(30min) Normal Temperature(15min)	5 cycles	0/16
Wet High Temp. Storage Life	EIAJ ED- 4701/100(103)	$Ta = 60 \pm 2^{\circ}C$, RH = $90 \pm 5\%$	1,000 h	0/16
High Temp. Storage Life	EIAJ ED- 4701/200(201)	Ta = Maximum Rated Storage Temperature	1,000 h	0/16
Low Temp. Storage Life	EIAJ ED- 4701/200(202)	Ta = Minimum Rated Storage Temperature	1,000 h	0/16
Vibration, Variable Frequency	EIAJ ED- 4701/400(403)	98.1m/s ² (10G), 100 ~ 2KHz sweep for 20min., XYZ each direction	2 h	0/16

Failure Criteria

Items	Symbols	Conditions	Failure criteria
Photo Current	I _C	EE Value of each product Irradiance of Photo Current V _{CE} Value of each product Collector-emitter Voltage of Photo Current	Testing Max. Value ≧ Initial Value x 1.3 Testing Min. Value ≦ Initial Value x 0.7
Dark Current	I _{CEO}	VŒO Value of each product Collector-emitter Voltage of Dark Current	Testing Max. Value ≧ Spec. Max. Value x 1.2





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